

SURFACE MOUNT SILICON HIGH SPEED SWITCHING DIODE





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD914 is a ultra-high speed silicon switching diode manufactured by the epitaxial planar process, in an epoxy molded surface mount package, designed for high speed switching applications.

MARKING CODE: C5D

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	V _R	75	V
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Continuous Forward Current	۱ _F	250	mA
Peak Repetitive Forward Current	IFRM	250	mA
Peak Forward Surge Current, tp=1.0µs	IFSM	4.0	A
Peak Forward Surge Current, tp=1.0ms	IFSM	2.0	А
Peak Forward Surge Current, tp=1.0s	IFSM	1.0	A
Power Dissipation	PD	350	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	357	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I _R	V _R =20V		25	nA
I _R	V _R =75V		5.0	μΑ
вv _R	Ι _R =100μΑ	100		V
VF	I _F =10mA		1.0	V
CJ	V _R =0, f=1.0MHz		4.0	pF
t _{rr}	$I_R=I_F=10$ mA, $I_{rr}=1.0$ mA, $R_L=100\Omega$		4.0	ns

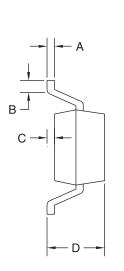
R7 (12-January 2016)

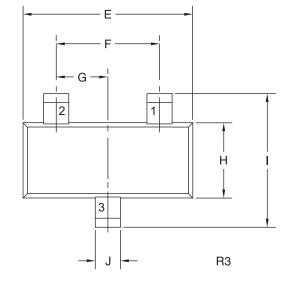


CMPD914

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SOT-23 CASE - MECHANICAL OUTLINE





PIN CONFIGURATION

3

LEAD CODE: 1) Anode

2) No Connection
3) Cathode

MARKING CODE: C5D

DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
А	0.003	0.007	0.08	0.18		
В	0.006	-	0.15	-		
С	-	0.005	-	0.13		
D	0.035	0.043	0.89	1.09		
E	0.110	0.120	2.80	3.05		
F	0.075		1.90			
G	0.037		0.95			
Н	0.047	0.055	1.19	1.40		
	0.083	0.098	2.10	2.49		
J	0.014	0.020	0.35	0.50		

SOT-23 (REV: R3)

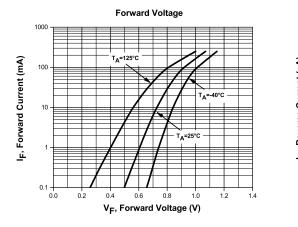
R7 (12-January 2016)

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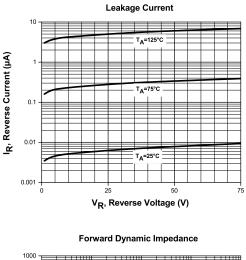




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TYPICAL ELECTRICAL CHARACTERISTICS





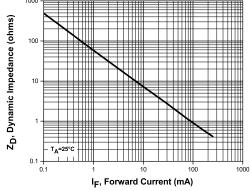
П

10

V_R, Reverse Voltage (V)

100

Capacitance





0.1 T_A=25°C

10

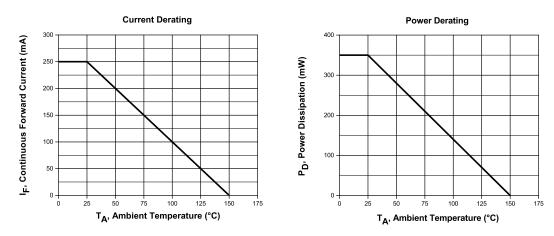
C, Capacitance (pF)

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TYPICAL ELECTRICAL CHARACTERISTICS

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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